

MULTI-INNO TECHNOLOGY CO., LTD.

www.multi-inno.com

LCD MODULE SPECIFICATION

Model : MI0500PT-7

This module uses ROHS material

For Customer's Acceptance:

Customer	
Approved	
Comment	

The standard product specification may change without	Revision	1.7
prior notice in order to improve performance or quality.	Engineering	
Thease contact with mino for updated specification and		
product status before design for the standard product or	Date	2018-09-27
	Our Reference	



REVISION RECORD

REV NO.	REV DATE	CONTENTS	REMARKS
1.0	2013-12-03	First release	
1.1	2014-07-16	LED life time changed from 20000(min) to 30000 hours(min),50000 hours(typ)	P.6
1.2	2015-02-02	Correcet the marked dimensions	P.5
1.3	2015-08-05	Delete the internal structure lines of backlight on the front viewing of the outline drawing, no change at TFT design and TFT product at all.	P.5
1.4	2015-08-05	Add FPC marked dimension	P.5
1.5	2018-01-31	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	P.7
1.6	2018-03-07	Error correction: 1. from: 31 STBYB to: 31 STBYB Depty combined/prode control pin- to: 1000000000000000000000000000000000000	P.9 P.6 P.14
1.7	2018-09-27	Spec. correction only, products have no changes. Correct the thickness from 3.1mm (max). to 3.0+/-0.2mm. Spec. correction only, products have no changes.	P.4, P.5



CONTENTS

- GENERAL INFORMATION
- EXTERNAL DIMENSIONS
- ABSOLUTE MAXIMUM RATINGS
- ELECTRICAL CHARACTERISTICS
- BACKLIGHT CHARACTERISTICS
- ELECTRO-OPTICAL CHARACTERISTICS
- INTERFACE DESCRIPTION
- APPLICATION CIRCUIT NOTES
- RELIABILITY TEST
- INSPECTION CRITERION
- PRECAUTIONS FOR USING LCD MODULES
- USING LCD MODULES
- PRIOR CONSULT MATTER



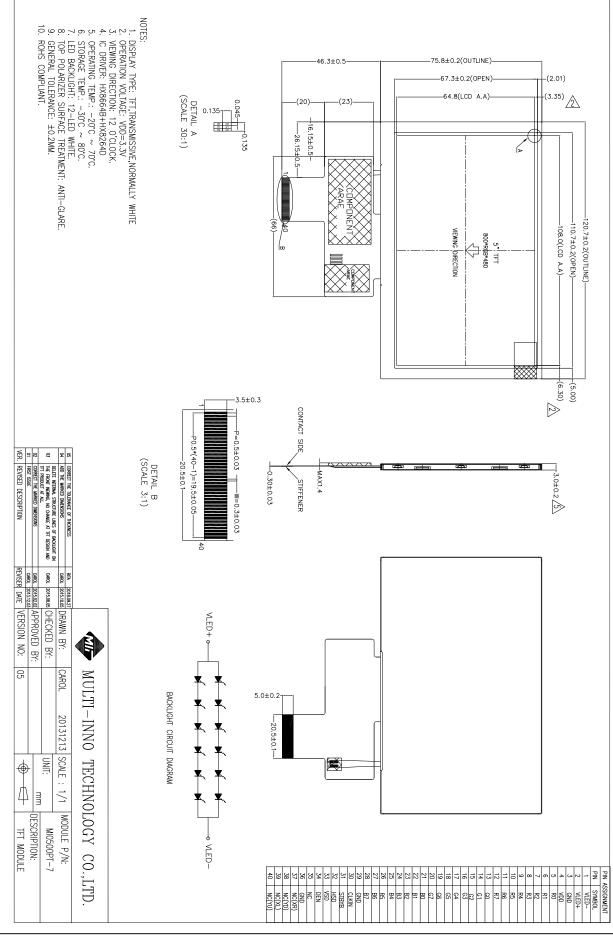
GENERAL INFORMATION

Item	Contents	Unit
LCD type	TFT/Transmissive/Normally white	/
Size	5.0	Inch
Viewing direction	12:00(without image inversion and least brightness	O' Clock
	change)	
Gray scale inversion direction	6:00 (contrast peak located at)	O' Clock
$LCM(W \times H \times D)$	120.7×75.8×3.0	mm ³
Active area (W×H)	108.0×64.8	mm^2
Pixel pitch (W×H)	0.135×0.135	mm^2
Number of dots	800 (RGB) × 480	/
Driver IC	HX8664B+HX8264D	/
Backlight type	12 LEDs	/
Interface type	24bit RGB	/
Color depth	16.7M	/
Pixel arrangement	RGB vertical stripe	/
Top polarizer surface treatment	Anti-glare	/
Backlight power consumption	730	mW
Panel power consumption	350	mW
Input voltage	3.3	V
With/Without TSP	Without TSP	/
Weight	TBD	g

Note 1: RoHS compliant; Note 2: LCM weight tolerance: $\pm 5\%$.



EXTERNAL DIMENSIONS



■ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
Supply voltage for logic	VDD	-0.3	4.0	V
Input voltage for logic	VIN	-0.5	VDD+0.3	V
Supply current (one LED)	I led	-	60	mA
Operating temperature	Тор	-20	70	°C
Storage temperature	Тѕт	-30	80	°C

■ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Min	Тур	Max	Unit
Supply voltage	VDD	3.0	3.3	3.6	V
Input leakage current	ILKG	-	-	-	μA
Input voltage ' H ' level	VIH	0.7VDD	-	VDD	V
Input voltage ' L ' level	Vil	0	-	0.3VDD	V

■ BACKLIGHT CHARACTERISTICS

Item	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward voltage	Vf	-	19.2	-	V	Ta=25±2°C,
Forward current	If	-	40	-	mA	, í
Power consumption	WBL	-	768	-	mW	60%RH±5%
Operating life time	-	30000	50000	-	Hrs	

Note :

Operating life time means brightness goes down to 50% initial brightness;

The life time of LED will be reduced if LED is driven by high current, high ambient temperature and humidity conditions;

Typical operating life time is an estimated data.

Item		Symbol	Condition	Min	Тур	Max	Unit	Remark	Note
Response	time	Tr+Tf		-	20	-	ms	FIG 1.	4
Contrast r	atio	Cr	θ=0°	-	500	-		FIG 2.	1
	Luminance uniformity		Ø=0° Ta=25℃	75	80	-	%	FIG 2.	3
Surface Lum	inance	Lv		550	600	-	cd/m ²	FIG 2.	2
			$\emptyset = 90^{\circ}$	40	50	-	deg	FIG 3.	
Viewing angl	0 100000	θ		60	70	-	deg	FIG 3.	6
viewing angi	Viewing angle range	Ø		60	70	-	deg	FIG 3.	
			$\emptyset = 180^{\circ}$	60	70	-	deg	FIG 3.	
	Red	X		0.539	0.589	0.639			
	Reu	у]	0.303	0.353	0.403			
	Green	X	θ=0°	0.302	0.352	0.402			
CIE (x, y)		у	0=0 $\emptyset=0^{\circ}$	0.538	0.588	0.638		FIG 2.	5
chromaticity	Blue	X	Ta=25℃	0.095	0.145	0.195		110 2.	5
	Diue	у	1 a-25 C	0.055	0.105	0.155			
	White	X		0.262	0.312	0.362			
		у		0.289	0.339	0.389			

■ELECTRO-OPTICAL CHARACTERISTICS

Note 1. Contrast Ratio(CR) is defined mathematically as For more information see FIG 2.:

Contrast Ratio = $\frac{\text{Average Surface Luminance with all white pixels (P_1, P_2, P_3, P_4, P_5)}{\text{Average Surface Luminance with all black pixels (P_1, P_2, P_3, P_4, P_5)}$

Average Surface Luminance with all black pixels $(P_1, P_2, P_3, P_4, P_5)$

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv = Average Surface Luminance with all white pixels $(P_1, P_2, P_3, P_4, P_5)$

Note 3. The uniformity in surface luminance , δ WHITE is determined by measuring luminance at each test position 1 through 5, and then dividing the maximum luminance of 5 points luminance by minimum luminance of 5 points luminance. For more information see FIG 2.

 $\delta \text{ WHITE} = \frac{\text{Minimum Surface Luminance with all white pixels } (P_1, P_2, P_3, P_4, P_5)}{\text{Maximum Surface Luminance with all white pixels } (P_1, P_2, P_3, P_4, P_5)}$

Note 4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1. The test equipment is Autronic-Melchers's ConoScope. Series

Note 5. CIE (x, y) chromaticity, The x, y value is determined by measuring luminance at each test position 1 through 5, and then make average value

Note 6. Viewing angle is the angle at which the contrast ratio is greater than 2. For TFT module the conrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

Note 7. For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity,CIE The test data is base on TOPCON's BM-5 photo detector.

Note 8. For TFT module, Gray scale reverse occurs in the direction of panel viewing angle.



FIG.1. The definition of Response Time

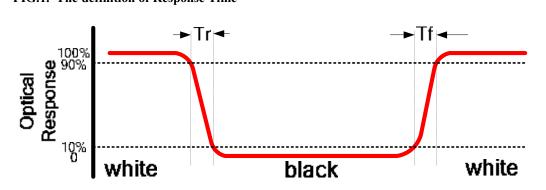


FIG.2. Measuring method for Contrast ratio, surface luminance, Luminance uniformity, CIE (x, y) chromaticity

A : 5 mm B : 5 mm H,V : Active Area Light spot size \emptyset =5mm, 500mm distance from the LCD surface to detector lens measurement instrument is TOPCON's luminance meter BM-5

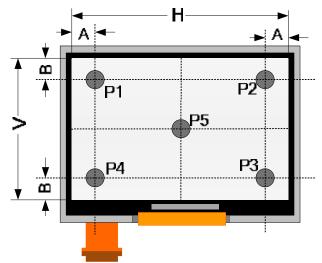
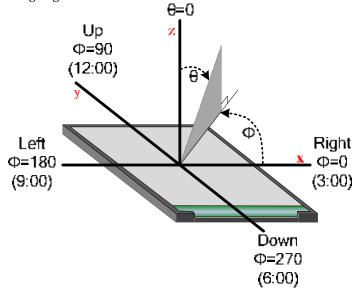


FIG.3. The definition of viewing angle





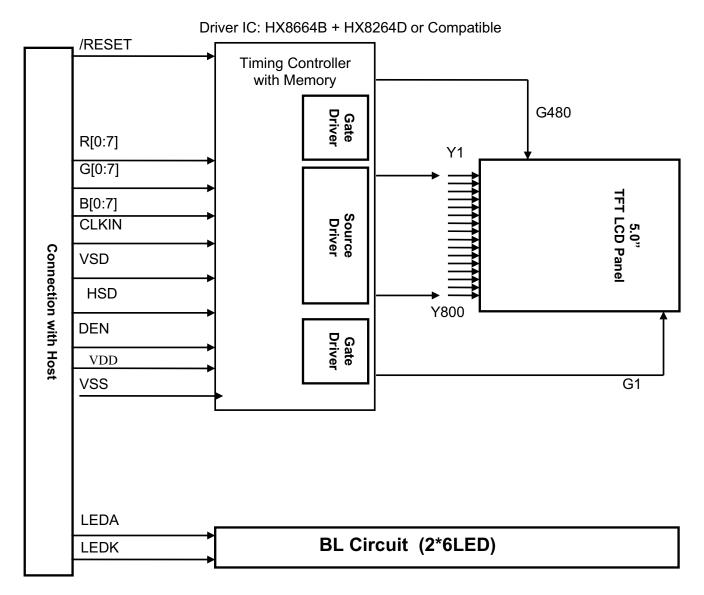
■ INTERFACE DESCRIPTION

NO.	SYMBOL	DESCRIPTION
1	VLED-	Cathode of LED backlight.
2	VLED+	Anode of LED backlight.
3	GND	Ground.
4	VDD	Power supply.
5	R 0	Red data.(LSB)
6	R1	Red data.
7	R2	Red data.
8	R3	Red data.
9	R4	Red data.
10	R5	Red data.
11	R6	Red data.
12	R7	Red data.(MSB)
13	G0	Green data.(LSB)
14	G1	Green data.
15	G2	Green data.
16	G3	Green data.
17	G4	Green data.
18	G5	Green data.
19	G6	Green data.
20	G7	Green data.(MSB)
21	B 0	Blue bus.(LSB)
22	B1	Blue bus.
23	B2	Blue bus.
24	B3	Blue bus.
25	B4	Blue bus.
26	В5	Blue bus.
27	B6	Blue bus.
28	B7	Blue bus.(MSB)
29	GND	Power supply.
30	CLKIN	Pixel clock, data sampling at the CLKIN falling edge.
31	STBYB	Display control/standby mode selection. STBYB="Low": Standby;(Default) STBYB="High": Normal display.
32	HSD	Horizontal sync signal.
33	VSD	Vertical sync signal.
34	DEN	Data input enable.
35	NC	No connection.
36	GND	Ground.
37	XR	TP right electrode.
38	YD	TP bottom electrode.
39	XL	TP left electrode.
40	YU	TP top electrode.

NOTE:For digital RGB input data format, both SYNC mode and DE+SYNC mode are supported. If ENB signal is fixed low. SYNC mode is used. Otherwise, DEN+SYNC is used



■ BLOCK DIAGRAM





■ APPLICATION CIRCUIT NOTES

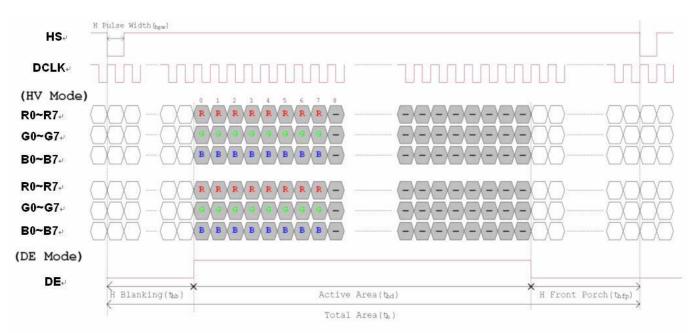
1. AC Characteristics

1.1 AC electrical characteristics

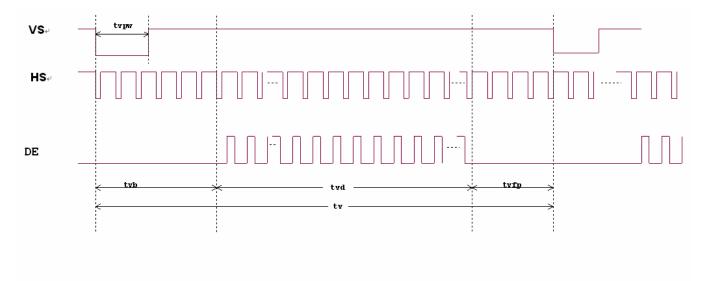
Itom	Symbol		Values		Unit	Remark
Item	Symbol	Min.	Тур.	Max.	Unit	Kelliark
HS setup time	Thst	8	-	-	ns	
HS hold time	Thhd	8	-	-	ns	
VS setup time	Tvst	8	-	-	ns	
VS hold time	Tvhd	8	-	-	ns	
Data setup time	Tdsu	8	-	-	ns	
Data hold time	Tdhd	8	-	-	ns	
DE setup time	Tesu	8	-	-	ns	
DE hold time	Tehd	8	-	-	ns	
DV _{DD} Power On Slew rate	Tpor	-	-	20	ms	From 0 to 90% DV _{DD}
RESET pulse width	T _{Rst}	10	-	-	ms	
DCLK cycle time	Tcoh	20	-	-	ns	
DCLK pulse duty	Tcwh	40	50	60	%	



1.2 Data input format



Horizontal input timing diagram.



Vertical input timing diagram.



1.2.1 Timing

Item	Symphol		Values	Unit	Remark	
	Symbol	Min.	Тур.	Max.	Unit	Kemark
Horizontal Display Area	thd	-	800	-	DCLK	
DCLK Frequency	fclk		30	50	MHz	
One Horizontal Line	th	889	928	1143	DCLK	
HS pulse width	thpw	1	48-	255	DCLK	
HS Blanking	thb		88		DCLK	
HS Front Porch	thfp	1	40	255	DCLK	

Itom	Symphol		Values	Unit	Remark	
Item	Symbol -		Тур.	Max.	Unit	Kelliark
Vertical Display Area	tvd	-	480	-	TH	
VS period time	tv	513	525	767	TH	
VS pulse width	tvpw	3	3	255	TH	
VS Blanking	tvb		32		TH	
VS Front Porch	tvfp	1	13	255	TH	



Ver 1.7

■ RELIABILITY TEST

No.	Test Item	Test Condition	Remarks
1	High Temperature Storage Test	$80^{\circ}C \pm 2^{\circ}C/240$ Hrs.	Note2
2	Low Temperature Storage Test	$-30^{\circ}\text{C} \pm 2^{\circ}\text{C}/240\text{Hrs}.$	Note1,2
3	High Temperature Operation Test	70°C±2°C/120Hrs.	
4	Low Temperature Operation Test	-20°C±2°C/120Hrs.	Note1
5	High Temperature and High Humidity Operation Test	60±5℃, 90%RH 120Hrs.	Note1,2
6	Thermal Shock Test (Non-operating)	-30±2°C(30Min.)~25±2°C(5Min.)~80±2°C(30Min.) 10Cycles	
7	Vibration Test (Non-operating)	Frequency:10~55Hz Amplitude: 1.5mm Sweep Time: 11Mins Test Period: 6 Cycles For Each Direction Of X, Y, Z (Packing Condition)	
8	Shock Test (Non-operating)	100G, 6Ms Direction: ±X, ±Y, ±Z Cycle: 3 Times	
9	Electro Static Discharge Test	R:330Ω, C:150pF, 5points/panel Air: ±8KV, 5times; Contact:±4KV, 5times; (Environment:15°C ~35°C, 30%~60%, 86Kpa~106Kpa)	

Note 1: Without water condensation

Note 2: The function test shall be conducted after 2 hours storage at the room temperature and humidity after removed from the test chamber.



■ INSPECTION CRITERION

M	OUTGOING QUALITY STANDARD	PAGE 1 OF 7
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA		MDS Product

This specification is made to be used as the standard acceptance/rejection criteria for TFT module.

1 Sample plan

Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993, normal level 2 and based on:

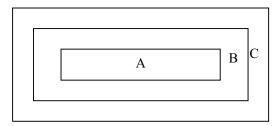
Major defect: AQL 0.65

Minor defect: AQL 1.5

2. Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of 20~40W light intensity, all directions for inspecting the sample should be within 45° against perpendicular line.

3. Definition of inspection zone in LCD.



Zone A: character/Digit area

Zone B: viewing area except Zone A (ZoneA+ZoneB=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD.

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.



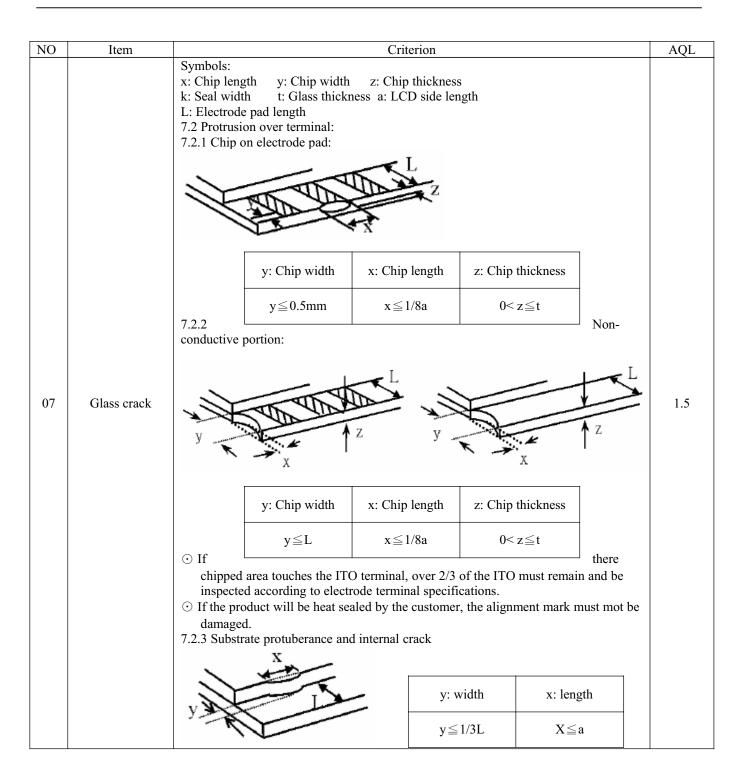
4. Inspection standards

NO	Item	Criterion			AQL	
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Flicker 			0.65	
02	Black or White spots or Bright spots or Color spots on LCD (Display only)	2.1 White and black or color spots on display ≤ 0.25 mm, no more than Five spots.2.2 Densely spaced: No more than three spots within 3mm.			1.5	
	LCD and Touch Panel black spots,	3.1 Round type: As follow $\Phi = (X+Y) / 2$ \downarrow	* Densely	Size(mm) $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi \le 0.30$ $0.30 < \Phi$ spaced: No more that	Acceptable Q'ty Accept no dense 2 2 1 0 n two spots within 3mm.	1.5
03	white spots, contamination (non – display)	3.2 Line type: (As following W	$ Length(m m) \\ \\ L \leq 3.0 \\ L \leq 2.5 \\ $	Width(mm) W≤0.02 0.02 <w≤0.05< td=""> 0.03<w≤0.08< td=""> 0.08<w< td=""> spaced: No more that</w<></w≤0.08<></w≤0.05<>	Acceptable Q'ty Accept no dense 2 Rejection an two lines within 3mm.	1.5



NO	Item	Criterion			AQL	
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction	(0.20) (0.50)	$e \Phi(mm)$ $e \le 0.20$ $< \Phi \le 0.50$ $< \Phi \le 1.00$ $harrow 0$	Acceptable Q'ty Accept no dense 3 2 0 3	1.5
05	Scratches	Follow NO.3 -2 Line Typ	be.			
06	Chipped glass	L: Electrode pad length 6.1 General glass chip: 6.1.1 Chip on panel surfa $\boxed{z: Chip thickness}$ $\boxed{Z \leq 1/2t}$ $1/2t < z \leq 2t$ mm	 width z: Chip thickness at LCD side left thickness at LCD side left at LCD side le	high ls: x: Chip len $x \le 1$	/8a /8a ⊙ Unit: ngth /8a	1.5
			chips, x is the total length o	of each chip		







NO	Item	Criterion	AQL
08	Cracked glass	The LCD with extensive crack is not acceptable.	
09	Backlight elements	 9.1 Illumination source flickers when lit. 9.2 Spots or scratches that appear when lit must be judged. Using LCD spot, lines and contamination standards. 9.3 Backlight doesn't light or color is wrong. 	1.5 1.5 0.65
10	Bezel	Bezel must comply with product specifications.	1.5
11	РСВ、СОВ	 11.1 COB seal may not have pinholes larger than 0.2mm or contamination. 11.2 COB seal surface may not have pinholes through to the IC. 11.3 The height of the COB should not exceed the height indicated in the assembly diagram. 11.4 There may not be more than 2mm of sealant outside the seal area on PCB. And there should be no more than three places. 11.5 Parts on PCB must be the same as on the production characteristic chart, There should be no wrong parts, missing parts or excess parts. 11.6 The jumper on the PCB should conform to the product characteristic chart. 	1.5 1.5 1.5 1.5 0.65 0.65
12	FPC	12.1 FPC terminal damage $\leq 1/2$ FPC terminal width and can not affect the function , we judge accept. 12.2 FPC alignment hole damage $\leq 1/2$ alignment area and can not affect the function , we judge accept.	1.5 1.5
13	Soldering	13.1 No cold solder joints, missing solder connections, oxidation or icicle.13.2 No short circuits in components on PCB or FPC.	1.5 0.65



NO

Item

Criterion

110			0111011			
		Symbols: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Touch Panel Total thickness a: LCD side length L: Electrode pad length 14.1.1 Chip on panel surface and crack between panels: 14.1.1 Chip on panel surface and crack between panels:				
		z: Chip thickness	y: Chip width	x: Chip length		
14	Touch Panel Chipped glass	Z≦t	$\leq 1/2$ k and not over viewing area	x≦1/8a	$ \begin{bmatrix} \odot \text{ Unit:} \\ mm \\ \odot \text{ If} \end{bmatrix} $	1.5
		there are 2 or more chips 14.1.2 Corner crack:	e, x is the total length of each	chip		
		z: Chip thickness	y: Chip width	x: Chip length		
		z≦t	$\leq 1/2$ k and not over viewing area	x≦1/8a	$ \bigcirc \text{Unit:} \\ mm \\ \odot \text{ If} $	
		there are 2 or more chips	, x is the total length of each	chip	- 0 11	

AQL



NO	Item	Criterion		
15	Touch Panel(Fish eye、dent and bubble on film)	SIZE(mm)Acceptable Q'ty $\Phi \leq 0.2$ Accept no dense $0.2 < D \leq 0.4$ 5 $0.4 < D \leq 0.5$ 2 $0.5 < D$ 0	1.5	
16	Touch Panel Newton ring	Newton ring dimension $\leq 1/2$ touch panel area and not affect font and line distortion($\leq 2.5\%$), it is acceptable.		
17	Touch Panel Linearity	Less than 2.5% is acceptable.		
18	LCD Ripple	Touch the touch panel , can not see the LCD ripple. Pen: R 1.0mm silicon rubber. Operation Force: 80g		
19	General appearance	 19.1 Pin type must match type in specification sheet. 19.2 LCD pin loose or missing pins. 19.3 Product packaging must the same as specified on packaging specification sheet. 19.4 Product dimension and structure must conform to product specification sheet. 		



PRECAUTIONS FOR USING LCD MODULES

1 Handing Precautions

- 1.1 The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- 1.2 If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- 1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
- 1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on it. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming in to contact with room temperature air.
- 1.5 If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
 - Isopropyl alcohol
 - Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

- 1.6 Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contact with oil and fats.

- 1.7 Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- 1.8 Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- 1.9 Do not attempt to disassemble or process the LCD module.
- 1.10 NC terminal should be open. Do not connect anything.
- 1.11 If the logic circuit power is off, do not apply the input signals.
- 1.12 Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

- Before removing LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.

- Tools required for assembling, such as soldering irons, must be properly grounded. Make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.

- To reduce the amount of static electricity generated, do not conduct assembling





and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dry. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.

- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

1.13 Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.

- Do not alter, modify or change the shape of the tab on the metal frame.

- Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.

- Do not damage or modify the pattern writing on the printed circuit board.

- Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.

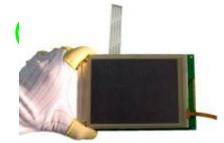
- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.

- Do not drop, bend or twist the LCM.

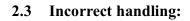


- 2 Handling precaution for LCM
 - 2.1 LCM is easy to be damaged. Please note below and be careful for handling.
 - 2.2 Correct handling:





As above picture, please handle with anti-static gloves around LCM edges.





Please don't touch IC directly.



Please don't hold the surface of panel.



Please don't hold the surface of IC.



Please don't stack LCM.



Please don't stretch interface of output, such as FPC cable.



Please don't operate with sharp stick such as pens.

3 Storage Precautions

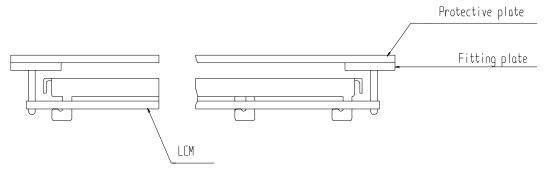
- 3.1 When storing the LCD modules, the following precaution are necessary.
 - 3.1.1 Store them in a sealed polyethylene bag. If properly sealed, there is no need for the desiccant.
 - 3.1.2 Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C, and keep the relative humidity between 40%RH and 60%RH.
 - 3.1.3 The polarizer surface should not come in contact with any other objects (We advise you to store them in the anti-static electricity container in which they were shipped).
- 3.2 Others 其它
 - 3.2.1 Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.
 - 3.2.2 If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
 - 3.2.3 To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.
 - 3.2.3.1 Exposed area of the printed circuit board.
 - 3.2.3.2 -Terminal electrode sections.

4 USING LCD MODULES

4.1 Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

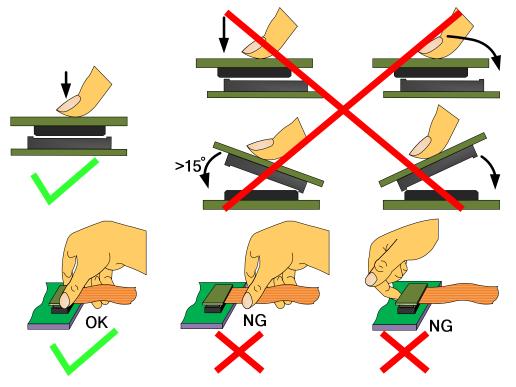
4.1.1 Cover the surface with a transparent protective plate to protect the polarizer and LC cell.



4.1.2 When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be ± 0.1 mm.



- Ver 1.7
- 4.2 Precaution for assemble the module with BTB connector: Please note the position of the male and female connector position, don't assemble or assemble like the method which the following picture shows



4.3 Precaution for soldering the LCM

	Manual soldering	Machine drag soldering	Machine press soldering
No RoHS	290°C ~350°C.	330°C ~350°C.	300°C ~330°C.
Product	Time : 3-5S.	Speed : 15-17 mm/s.	Time : 3-6S.
Floduct			Press: 0.8~1.2Mpa
RoHS	340°C ∼370°C.	350°C ~370°C.	330°C ~360°C.
Product	Time : 3-5S.	Speed : 15-17 mm/s.	Time : 3-6S.
Tioduct			Press: 0.8~1.2Mpa

- 4.3.1 If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation (This does not apply in the case of a non-halogen type of flux). It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.
- 4.3.2 When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- 4.3.3 When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

4.4 Precautions for Operation

- 4.4.1 Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.
- 4.4.2 It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- 4.4.3 Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operating temperature.
- 4.4.4 If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- 4.4.5 A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature, 50%RH or less is required.
- 4.4.6 Input logic voltage before apply analog high voltage such as LCD driving voltage when power on. Remove analog high voltage before logic voltage when power off the module. Input each signal after the positive/negative voltage becomes stable.
- 4.4.7 Please keep the temperature within the specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

4.5 Safety

- 4.5.1 It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- 4.5.2 If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.



4.6 Limited Warranty

Unless agreed between Multi-Inno and the customer, Multi-Inno will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with Multi-Inno LCD acceptance standards (copies available upon request) for a period of one year from date of production. Cosmetic/visual defects must be returned to Multi-Inno within 90 days of shipment. Confirmation of such date shall be based on data code on product. The warranty liability of Multi-Inno limited to repair and/or replace on the terms set forth above. Multi-Inno will not be responsible for any subsequent or consequential events.

- 4.7 Return LCM under warranty
 - 4.7.1 No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :
 - 4.7.1.1 Broken LCD glass.
 - 4.7.1.2 PCB eyelet is damaged or modified.
 - 4.7.1.3 -PCB conductors damaged.
 - 4.7.1.4 Circuit modified in any way, including addition of components.

4.7.1.5 - PCB tampered with by grinding, engraving or painting varnish.

4.7.1.6 - Soldering to or modifying the bezel in any manner.

4.7.2 Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

■ PACKING SPECIFICATION

Please consult our technical department for detail information.

PRIOR CONSULT MATTER

- 1 For Multi-Inno standard products, we keep the right to change material, process ... for improving the product property without prior notice to our customer.
- 2 For OEM products, if any changes are needed which may affect the product property, we will consult with our customer in advance.
- 3 If you have special requirement about reliability condition, please let us know before you start the test on our samples.